2SC3553

Silicon NPN Epitaxial

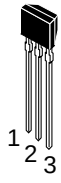
HITACHI

Application

Low frequency amplifier

Outline

SPAK



1. Emitter
2. Collector
3. Base

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Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	35	V
Collector to emitter voltage	V_{CEO}	35	V
Emitter to base voltage	V_{EBO}	4	V
Collector current	I_C	500	mA
Collector power dissipation	P_C	300	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C

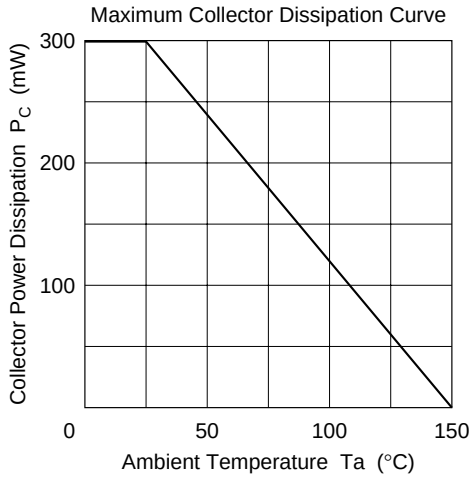
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	35	—	—	V	I_C = 10 µA, I_E = 0
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	35	—	—	V	I_C = 1 mA, R_{BE} = ∞
Emitter to base breakdown voltage	$V_{(BR)EBO}$	4	—	—	V	I_E = 10 µA, I_C = 0
Collector cutoff current	I_{CBO}	—	—	0.5	µA	V_{CB} = 20 V, I_E = 0
DC current transfer ratio	h_{FE1}*[1]	60	—	320		V_{CE} = 3 V, I_C = 10 mA
	h_{FE2}	10	—	—		V_{CE} = 3 V, I_C = 500 mA*[2]
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	0.2	0.6	V	I_C = 150 mA, I_B = 15 mA*[2]
Base to emitter voltage	V_{BE}	—	0.64	—	V	V_{CE} = 3 V, I_C = 10 mA

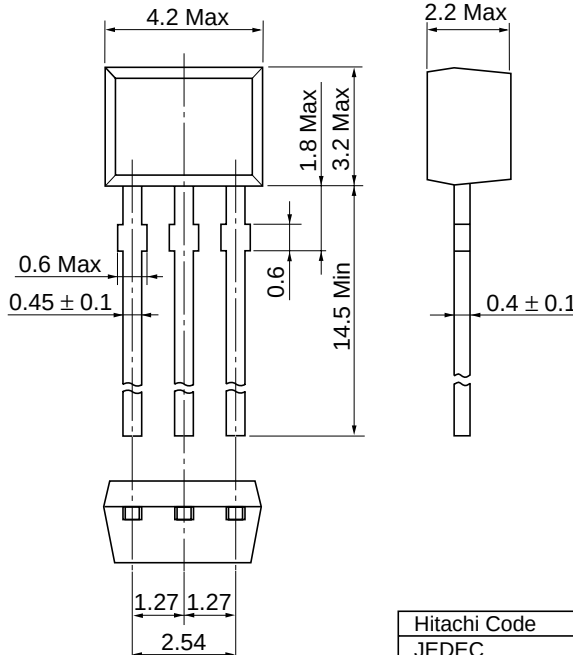
Notes: 1. The 2SC3553 is grouped by h_{FE1} as follows.
2. Pulse test

B	C	D
60 to 120	100 to 200	160 to 320

See characteristic curves of 2SC1213.


Maximum Collector Dissipation Curve
Collector Power Dissipation P_C (mW)
300
200
100
0
50
100
150
Ambient Temperature Ta (°C)

Unit: mm



Hitachi Code	SPAK
JEDEC	—
EIAJ	—
Weight (reference value)	0.10 g

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